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#### DESCRIPTION

The SSI 32R2210R/2211R/2212R are BiCMOS monolithic integrated circuits designed for use with two-terminal recording heads. They provide a low noise read amplifier, write current control, and data protection circuitry for up to four channels. The SSI 32R2210R/2211R/2212R option provides internal  $350\Omega$ damping resistors. Damping resistors are switched in during write mode and switched out during read mode. The SSI 32R2210/2211/2212 option does not provide damping resistors. Power supply fault protection is provided by disabling the write current generator during power sequencing. System write to read recovery time is significantly improved by making the read channel outputs high impedance. The device also offers multiple channel "servo bank write" capability to assist in servo writing operations.

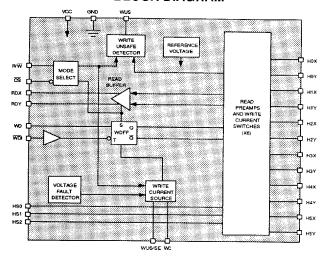
The SSI 32R2210R/2211R/2212R require only a +5V power supply and are available in a variety of packages. The 32R2211R is hardware compatible with the SSI 32R4610AR and SSI 32R2020R Read/Write devices.

#### **FEATURES**

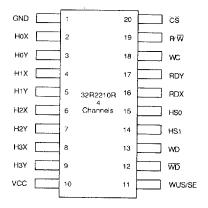
- +5V ±10% supply
- Low power
  - PD = 105 mW read mode (Nom)
  - PD = 1.0 mW Idle (Max)
- High Performance:
  - Read mode gain = 300 V/V
  - Input noise = 0.50 nV/ $\sqrt{\text{Hz}}$  (Nom)
  - Input capacitance = 7 pF (Nom)
  - Write current range = 3-25 mA
  - Nominal write current (20 mA) rise/fall time = 7.7 ns (Nom) (typical head)
  - Head voltage swing = 7.8 Vpp (Nom)
- Servo bank-write capability
- Self switching damping resistance
- Write unsafe detection

(continued)

#### **BLOCK DIAGRAM**



### **PIN DIAGRAM**



20-Lead SOV, SOL

CAUTION: Use handling procedures necessary for a static sensitive component.

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### FEATURES (continued)

- · Power supply fault protection
- · Head short to ground protection
- Differential ECL-like (32R2210R/2212R) or TTL (32R2211R) write data inputs
- Write Data Flip/Flop (32R2210R/2211R) or no Flip/Flop (32R2212R)

### **FUNCTIONAL DESCRIPTION**

The SSI 32R2210R/2211R/2212R have the ability to address up to 4 two-terminal heads and provide write drive or read amplification. Mode control and head selection are described in Tables 1 and 2. The TTL inputs R/W and CS have internal pull-up resistors to prevent an accidental write condition. HS0 and HS1 have internal pull down resistors. Internal clamp circuitry will protect the IC from a head short to ground condition in any mode.

**TABLE 1: Mode Select** 

CS	R/W	WUS/SE	Mode
0	0	*	Single Channel Write. See Table 2.
0	0	**	Servo Write.
0	1	X	Single Channel Read. See Table 2.
1	X	Х	Idle.

<sup>\*</sup> WUS/SE is a WUS output unless pulled above VCC.

**TABLE 2: Head Select** 

HS1	HS0	Head
0	. 0	0
0	1	1
1	0	2
1	1	3

TABLE 3: Head Select in Servo Write Mode (2210R/2211R)\*

Head Select Address HS1 HS0		Head Selected in Servo Write Mode		
0	0	0, 1		
0	1	0, 1		
1	0	2, 3		
1	1	0, 1, 2, 3		

<sup>\*</sup> Note: For 2-channel parts, heads 0 & 1 are selected in servo write mode, independent of head select address.

TABLE 4: Head Select in Servo Write Mode (2212R)

(== :=::)			
Head Select Address HS1*   HS0		Head Selected in Servo Write Mode	
0	0	0, 1	
0	1	0, 1, 2, 3	
1	0	2, 3	
1	1	0, 1, 2, 3	

<sup>\*</sup> Note: For 2-channel parts, HS1 = 0.

<sup>\*\*</sup> Servo write mode is activated through the WUS pin as described in the servo write mode section.

### WRITE MODE

Taking both CS and R/W low selects write mode which configures the SSI 32R2210R/2211R/2212R as a current switch and activates the Write Unsafe (WUS) detector circuitry. On the 32R2210R, head current is toggled between the X and Y side of the selected head on each low to high transition of WD-WD. On the 32R2211R, head current is toggled between the X and Y side of the selected head on each high to low transition of the Write Data Input (WDI). Note that a preceding Read to Write transition or Idle to Write transition initializes the Write Data Flip-Flop to pass write current into the "X" side of the device. In this case, the Y side is higher potential than the X side. With the 32R2212R, head current is toggled between the X and Y side of the head on each WDX-WDY transition. When the potential of WDX is higher than WDY, the potential on the X side of the head is higher than the Y-Side (HNY is sinking current). The magnitude of the write current (0-pk) is given by:

$$Iw = Aw \cdot \frac{Vwc}{Rwc} = \frac{K}{Rwc}$$

where Aw is the write current gain.

RWC is connected from pin WC to GND. Note the actual head current lx, y is given by:

Where:

$$k, y = \frac{lw}{1 + Rh/Rc}$$

Rh = Head resistance plus external wire resistance

Rd = Damping resistance

In write mode a  $350\Omega$  damping resistor is switched in across the Hx, Hy ports (32R2210R/2211R/2212R only).

#### **SERVO WRITE MODE**

This mode allows for writing to multiple channels at once, which is useful during servo formatting.

To enable servo write mode follow these steps:

- (1) Place the device in the read mode (R/W high).
- (2) Set the head select lines to an address that corresponds to the bank of heads desired for servo write (See Tables 3 and 4).

(3a) If SE pin is available, make it low.

- (3b)If SE pin is not available, pull the WUS output above Vcc by sourcing 10 mA of current into the pin. Two ways to source this current are: (a) use a voltage source set to Vcc +1.9 volts limited to 10 mA current, or (b) use a resistor tied between WUS and a supply above Vcc to source the current. With 10 mA of current, WUS will rise to approximately Vcc + 1.5 volts.
- (4) Allow at least 1 μs setup.
- (5) While maintaining steps (2) and (3) above make R/W low, placing the device in servo write mode.

#### POWER SUPPLY FAULT PROTECTION

A voltage fault detection circuit improves data security by disabling the write current generator during a voltage fault or power startup regardless of mode. Note that WUS does not necessarily turn on to flag a power supply fault condition.

#### HEAD SHORT TO GROUND PROTECTION

The SSI 32R2210R/2211R/2212R provides a head short to ground protection circuit in write mode. If the selected head is shorted to ground the write current generator will turn off, the WUS flag will go high, and current will be limited to less than 1 mA out of the head port. Note that any unselected head is pulled to ground through internal circuitry. In the idle mode, all heads are similarily pulled to ground.

In read mode, current out of the selected head port will not exceed 3 mA if the head is shorted to ground.

#### WRITE UNSAFE

Upon entering write mode, WUS is initialized low. Any of the following conditions will be indicated as a high level on the Write Unsafe, WUS, open collector output.

- Write data frequency too low
- · Device in read mode
- Device not selected
- No head current
- Open head
- Head short to ground

To insure no false WUS trigger, the product of head current and head resistance (lw  $\cdot$  Rh) should be less than [0.14 (lw) - 0.2] V, where lw is in mA, for lw range from 3 mA to 10 mA, and less than 1.2V for lw range from 10 mA to 35 mA. The open head detect circuit is also disabled when write data frequency is above 10 MHz to prevent false WUS detect.

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#### WRITE UNSAFE (continued)

**WDI frequency too low** is detected if the write data frequency falls below 500 kHz. Consult the WUS Safe to Unsafe timing for range of frequency detection.

Device in read mode, Device in servo write mode and Chip disabled will flag WUS if  $R/\overline{W}$  is high, if servo write mode is activated, or  $\overline{CS}$  is high.

No head current will flag WUS if Rwc =  $\infty$  and the selected head is present.

**Head opened** will flag WUS if  $Rh = \infty$  and the write data frequency is less than 10 MHz.

**Head short to ground** is described in the preceding paragraph.

#### **READ MODE**

The read mode configures the SSI 32R2210R/2211R/2212R as a low noise differential amplifier and deactivates the write current generator. The damping resistor is switched out of the circuit allowing a high impedance input to the read amplifier. The RDX and RDY output are driven by emitter followers. They should be AC coupled to the load. The HnX, HnY inputs are non-inverting to the RDX, RDY outputs.

Note that in idle or write mode, the read amplifier is deactivated and RDX, RDY outputs become high impedance. This facilitates multiple R/W applications (wired-OR RDX, RDY) and minimizes voltage change when switching from write to read mode. Note also that the write current source is deactivated for both the read and idle mode.

#### **IDLE MODE**

Taking  $\overline{CS}$  high selects the idle mode which switches the RDX and RDY outputs into a high impedance state and deactivates the device. Power consumption in this mode is held to a minimum.

### PIN DESCRIPTION

### CONTROL/STATUS

NAME	TYPE	DESCRIPTION
<u>CS</u>	1	Chip Select Input. A logical low level enables the device. This pin has an internal pull up.
R/W†		Read/Write. A logical high level enables read mode. A logical low level enables write mode. This pin has an internal pull up.
HS0, HS1	ı	Head Select. Decoded address (internal pull down) selects one of 4 channels. See Table 2.
WUS/SE†	1/0	Write Unsafe/Servo Enable. When in Servo Bank write mode, pulling this pin above Vcc enables servo bank write. See Servo write mode section. Otherwise, a high level indicates an unsafe writing condition. See WUS section.
SE	ı	Servo Enable. A logic low enables servo write mode.
WC†	1	Write Current. A resistor to ground from WC sets the write current through the recording head.

### **HEAD TERMINAL CONNECTIONS**

H0X-H3X	ı	X, Y Head Connections
H0Y-H3Y		

#### **DATA INPUT/OUTPUT**

WDI† (32R2211R)	ļ	Write Data In. A negative transition of WDI changes the direction of current in the recording head.
WD, WD† (32R2210R)	1	Differential Write Data In. A positive transition of WD-WD changes the direction of current in the recording head.
WD, WDY† (32R2212R)	1	Differential Write Data In. Each transition of WDX-WDY changes the direction of current in the recording head.
RDX, RDY†	0	Differential Read Data Out. Emitter follower output.

### **POWER**

VCC	ı	+5V power supply
GND	1	Ground

<sup>†</sup> When more than one Read/Write device is used, signals can be wire OR'ed.

## **ELECTRICAL SPECIFICATIONS**

Current maximums are currents with the highest absolute value.

## **ABSOLUTE MAXIMUM RATINGS**

Operation beyond the maximum ratings may damage the device.

PARAMETER			RATING	
DC Supply Voltage		VCC	-0.3 to 6 VDC	
Write Current		lw	65 mA	
Digital Input Volt	age	Vin	-0.3 to VCC + 0.3 VDC	
Head Port Voltage		VH	-0.3 to VCC + 0.3 VDC	
WUS Pin Voltag	е	Vwus	7.5 VDC	
Output Current	RDX,RDY	lo	-10 mA	
	WUS Iwus		+15 mA	
Junction Operating Temperature		Tj	+125°C	
Storage Temperature			-65 to +150°	

## RECOMMENDED OPERATING CONDITIONS

DC Supply Voltage	VCC	5 ± 10%V
Ambient Operating Temperature	Ta	0°C < Ta < 70°C

#### **TEST CONDITIONS**

Recommended operating conditions apply.

Write Current, Iw		20 mA	
Head Inductance, Lh		1 μΗ	
Head Resistance, Rh		30Ω	
WD Frequency		5 MHz	
WD, WD rise/fall time	32R2210R	1 ns	
WDI rise/fall time	32R2211R	1 ns	
WDX, WDY rise/fall time	32R2212R	1 ns	

### POWER DISSIPATION

Recommended operating conditions apply.

PARAMETER	CONDITIONS		MIN	NOM	MAX	UNIT
VCC Supply Current	Read mode	lw = 20 mA		21	30	mA
	Write mode	lw = 20 mA		42	55	mA
	ldle mode			0.04	0.2	mA
Power Dissipation	Read mode	iw = 20 mA		105	165	mW
	Write mode	lw = 20 mA		210	303	mW
	Idle mode			0.2	1	mW

## **DIGITAL INPUTS**

Input High Voltage HSX, CS, R/W, WDI	Vih		2			VDC
Input Low Voltage HSX, CS, R/W, WDI	Vil				0.8	VDC
Input High Current HSX, CS, R/W, WDI	lih	Vih ≃ 2V			100	μА
input Low Current HSX, CS, R/W, WDI	lil	Vil = 0.8V	-0.4			mA
WDX, WDY, WD, WD Input High Voltage	Vih	32R2210R, 32R2212R	Vcc - 1.1		Vcc - 0.4	VDC
WDX, WDY, WD, WD Input Low Voltage	Vil	32R2210R, 32R2212R	Vih - 2		Vih - 0.25	VDC
WDX, WDY, WD, WD Input High Current		Vih = Vcc-0.4V (32R2210R/2212R)		2	50	μΑ
WDX, WDY, WD, WD Input Low Current		Vih = Vcc-1.45V (32R2210R/2212R)	-50	0	50	μА
WUS Output Low Voltage	Vol	lol = 2 mA max		0.2	0.5	VDC

## **ELECTRICAL SPECIFICATIONS** (continued)

## WRITE CHARACTERISTICS

Test conditions apply unless otherwise specified.

PARAMETER	CONDITIONS	MIN	NOM	MAX	UNIT
Write Current Range		3		25	mA
Write Current Voltage Vwc			2		· V
Write Current Gain Aw	lw = Aw•Vwc/Rwc		26		mA/mA
Write Current Constant "K"	lw = K/Rwc	45	50	55	٧
Differential Head Voltage Swing	Open Head, lw = 20 mA	6.5	7.8		Vp-p
Head Differential Rd	32R2210/2211/2212	2.4	3	3.6	kΩ
Load Resistance	32R2210R/2211R/2212R	280	350	420	Ω
WD Pulse Width	PWH	5			ns
(See Figure 1)	PWL	5			ns
Unselected Head Voltage			0	0.1	VDC
Unselected Head Current	DC		0	0.2	mA
VCC Fault Voltage	lw ≤ 0.2 mA	3.4	3.8	4.3	V
Head Current HnX, HnY	VCC fault condition	-200		200	μА

### SERVO WRITE CHARACTERISTICS

Write Current Range		3		25	mA
Write Current Matching	Between channels		±10%		
WUS/SE Voltage	Servo Bank Write Enabled		Vcc + 1.5	Vcc + 1.9	V
WUS/SE Sink Current	Servo Bank Write Enabled	10			mA

### **READ CHARACTERISTICS**

Test conditions apply unless otherwise specified. CL (RDX, RDY) < 20 pF, RL (RDX, RDY) = 1 k $\Omega$ .

PARAMETER		CONDITIONS	MIN	МОМ	MAX	UNIT
Differential Voltage Gain		Vin = 1 mVpp @1 MHz	250	300	350	V/V
Voltage BW	-1 dB	Zs  < 5Ω, Vin = 1 mVp-p	30	40		MHz
	-3 dB		65	85		MHz
Input Noise Voltage		BW = 15 MHz, Lh = 0, Rh = 0		0.50	0.65	nV/√Hz
Input Noise Current				3.5		pA/√Hz
Differential Input Capacita	ance	Vin = 1 mVp-p, f = 5 MHz		7.5	12	рF
Differential Input Resistan	ice	Vin = 1 mVp-p, f = 5 MHz	500	850		Ω
Dynamic Range		AC input voltage where gain falls to 90% of its small signal gain value, f = 5 MHz	2	9		mVp-p
Common Mode Rejection Ratio		Vin = 0 VDC + 100 mVp-p @ 5 MHz	50	70		dB
Power Supply Rejection Ratio		100 mVpp @ 5 MHz on VCC	50	70		dB
Channel Separation		Unselected channels driven with Vin = 0 VDC + 100 mVp-p	50	60		dB
Output Offset Voltage		Lh = 0, Rh = 0	-250		+250	mV
Single Ended Output Resistance		f = 5 MHz		35	50	Ω
Output Current		AC coupled load, RDX to RDY	2	2.8		mA
RDX, RDY Common Mode Output Voltage				Vcc - 2.5		VDC

## **ELECTRICAL SPECIFICATIONS** (continued)

## SWITCHING CHARACTERISTICS

Test conditions apply unless otherwise specified.

PARAMETER		CONDITIONS	MIN	NOM	MAX	UNIT
Read to Write	R/W	R/W to 90% of write current		0.06	0.4	μs
Write to Read		R/W to 90% of 100 mV Read signal envelope		0.1	0.4	μѕ
Unselect to Select CS		CS to 90% of 100 mV 10 MHz Read signal envelope		0.08	0.6	μs
Select to Unselect		CS to 10% of write current		0.04	0.6	μs
HS0,1 to any Head		To 90% of 100 mV 10 MHz Read signal envelope		0.06	0.6	μS
Safe to Unsafe (TD1) WUS		Write mode, loss of WDI, WD transitions; Defines max WDI, WD period for WUS operation	0.6	2	3.6	μs
Unsafe to Safe (TD2)		Fault cleared: from first negative WDI transition		0.15	0.6	μs
WD to Ix - Iy (TD3)		From 50% points (Lh = 0, Rh = 0)		4	7	ns
Asymmetry		WDI has 1 ns rise/fall time (Lh = 0, Rh = 0)		0.1	0.5	ns
Rise/fall Time		10% to 90% points lw = 20 mA, Rh = 0, Lh = 0		1	3	ns
		Iw = 20 mA, Rh = $30\Omega$ , Lh = 1 $\mu$ H		7.7	10	ns

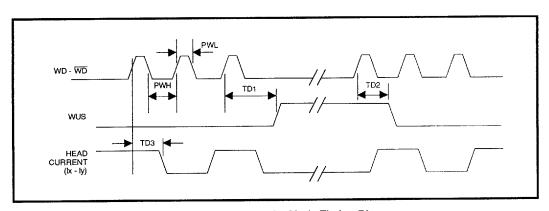


FIGURE 1: 32R2210R Write Mode Timing Diagram

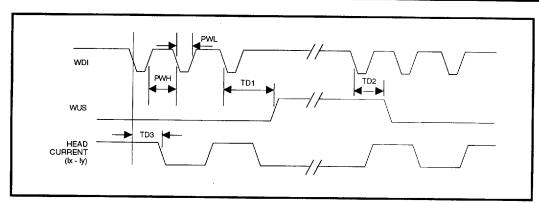


FIGURE 2: 32R2211R Write Mode Timing Diagram

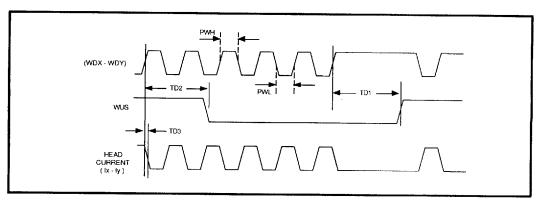
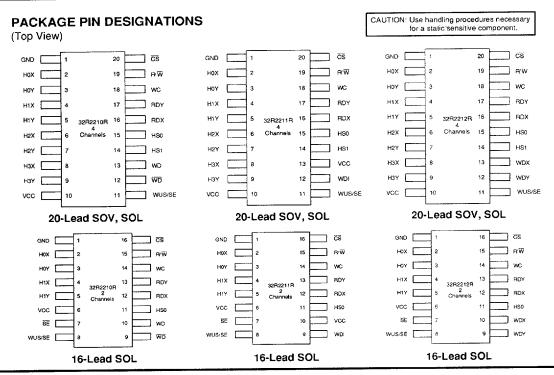


FIGURE 3: 32R2212R Write Mode Timing Diagram



### ORDERING INFORMATION

PART DESCRIPTION		ORDER NUMBER	PACKAGE MARK		
SSI 32R2210R	20-Lead SOV	32R2210R-4CV	32R2210R-4CV		
	20-Lead SOL	32R2210R-4CL	32R2210R-4CL		
	16-Lead SOL	32R2210R-2CL	32R2210R-2CL		
SSI 32R2211R	20-Lead SOV	32R2211R-4CV	32R2211R-4CV		
	20-Lead SOL	32R2211R-4CL	32R2211R-4CL		
	16-Lead SOL	32R2211R-2CL	32R2211R-2CL		
SSI 32R2212R	20-Lead SOV	32R2212R-4CV	32R2212R-4CV		
	20-Lead SOL	32R2212R-4CL	32R2212R-4CL		
	16-Lead SOL	32R2212R-2CL	32R2212R-2CL		

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Silicon Systems, Inc., 14351 Myford Road, Tustin, CA 92680-7022 (714) 573-6000, FAX (714) 573-6914

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